



WAFER WITHDRAWAL REQUEST FORM

Sl. No.

Please enter the no. of wafers purchased in FOM → "Purchase Supplies"

Wafer Specifications			
Type P-Type / N-Type / Thermal Oxide - 1 μ m SOI – Mention Device & BOX Thickness			
Wafer Size (2" / 3" / 4" / 6")			
Orientation			
Resistivity (Ω -cm)			
SSP / DSP (Single Side / Double Side Polished)			
Quantity			
Others			
Wafer Carrier Box Specifications			
Carrier Box Size (3" / 5")			
Quantity			

Requester's Details	
Name :	Department :
Designation :	Signature with Date :
Approver's Details – On Behalf of Requester	
Name :	Signature with Date :

Wafers will be issued only "Inside the Cleanroom".

FOR CeNSE OFFICE USE ONLY

Particulars of Wafer(s) Issued @ CeNSE
Wafer Spec :
Qty / Vendor :
Comments :

Approver's Details - CeNSE	Issuer's Details - CeNSE
Name :	Name :
Signature with Date :	Signature with Date :